## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date	
Shouji YAMAMOTO	05/23/2007	

#### **RECEIVING PARTY DATA**

Name:	NITTO DENKO CORPORATION			
Street Address:	1-2 Shimohozumi 1-chome, Ibaraki-shi			
City:	Osaka			
State/Country:	JAPAN			

#### PROPERTY NUMBERS Total: 1

Property Type	Number			
Application Number:	11757452			

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER: Mark Boland

Total Attachments: 1

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CH \$40.00

PATENT REEL: 019373 FRAME: 0387

# ASSIGNMENT

Whereas, I/we

Shouji YAMAMOTO of Osaka, Japan

hereinafter called assignor(s), have invented certain improvements in PRESSURE-SENSITIVE ADHESIVE SHEET FOR DICING AND METHOD FOR PROCESSING PROCESSED MATERIAL USING THE SAME and executed an application for Letters Patent of the United States of America therefor on

May 23, 2007; and

Whereas.

NITTO DENKO CORPORATION of 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka, Japan

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. § 119, and I/we request the Director – U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

l/We	hereby a	authorize	and request	my/our	attorneys	SUGI	HRUE	MION,	PLLC	of 2100
Pennsylvania	Avenue	, N.W.,	Washington,	D.C,	20037-3213	3 to	insert	here i	n pare	entheses
(Application n	umber			, filed	<u> </u>	11.11		) the	filing o	late and
application nu	mber of s	aid applic	cation when k	nown.						
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PATENT REEL: 019373 FRAME: 0388

RECORDED: 06/04/2007

Date: